

Application Notes for AP3771 System Solution

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1. Introduction

The AP3771 uses Pulse Frequency Modulation (PFM) method to realize Discontinuous Conduction Mode (DCM) operation for FLYBACK power supplies. The principle of PFM is different with that of Pulse Width Modulation (PWM), so the design of transformer is also different.

The AP3771 can provide accurate constant voltage, constant current (CV/CC) regulation by using Primary Side

Regulation (PSR). AP3771 has the special technique to suppress the audio noise, internal line compensation to reduce the number of system components, fixed cable compensation to compensate the voltage drop on different output cable for achieving good CV regulation.

The AP3771 can achieve low standby power less than 30mW.

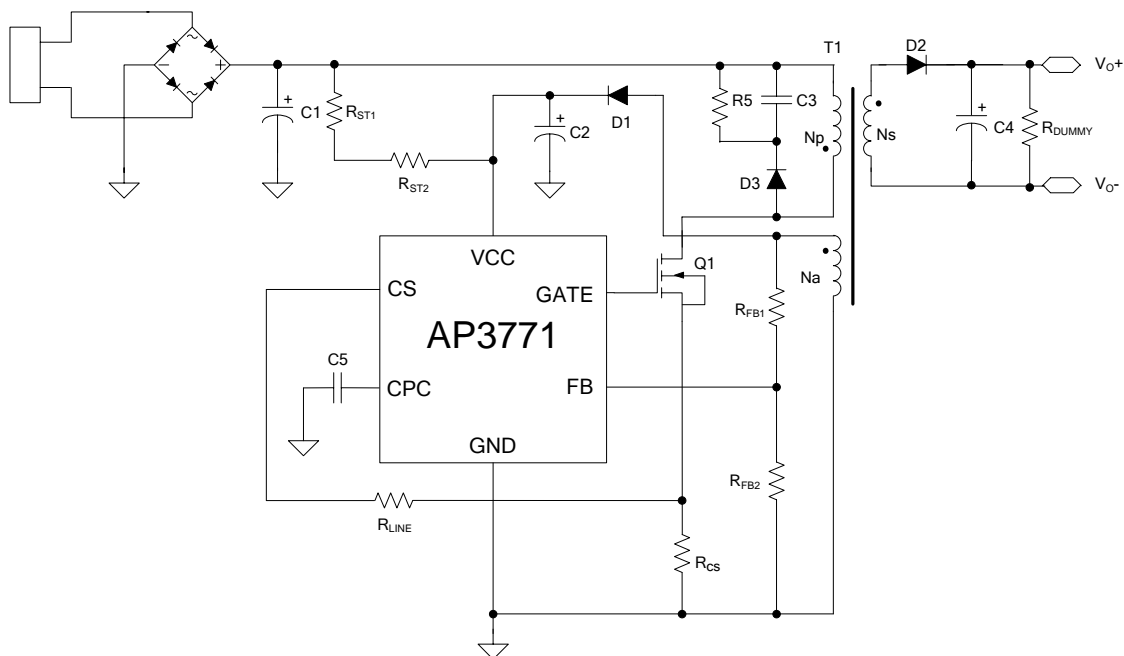


Figure 1. Typical Application Circuit of AP3771 for Adapter

Figure 1 is AP3771 typical application circuit, which is a FLYBACK converter controlled by AP3771 with a 3-winding transformer---Primary winding (N_p), Secondary winding (N_s) and Auxiliary winding (N_a). The AP3771 senses the auxiliary winding feedback voltage at FB pin and obtains power supply at VCC pin.

Figure 2 is the typical operation waveforms of PFM controller. In this figure, a series of relative ideal operation waveforms are given to illustrate some parameters used in following design steps. And the nomenclature of the parameters in Figure 2 is illustrated.

V_{dri} ---A simplified driving signal of primary MOSFET

V_{SEC} ---The transient voltage of secondary

V_S ---the sum of V_O and forward voltage of rectification diode

I_p ---The primary side current

I_s ---The secondary side current

I_{PK} ---Peak current of primary side

I_{PKS} ---Peak current of secondary side

t_{SW} ---The period of switching frequency

t_{ONP} ---The time of primary side "ON"

t_{ONS} ---The time of secondary side "ON"

t_{OFF} ---The discontinuous time

t_{OFFS} --- The time of secondary side "Off"

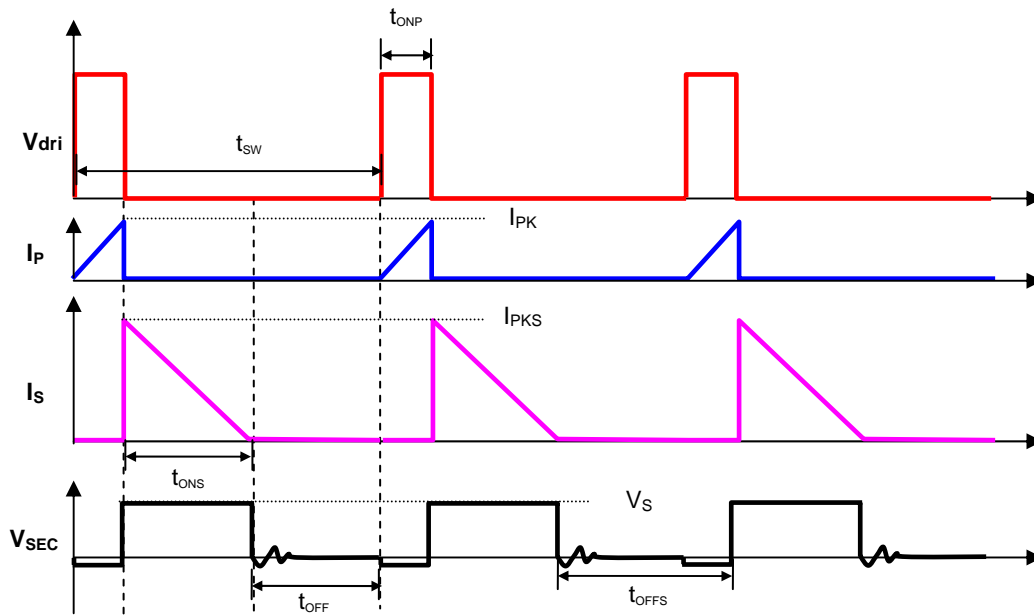


Figure 2. Operation Waveforms

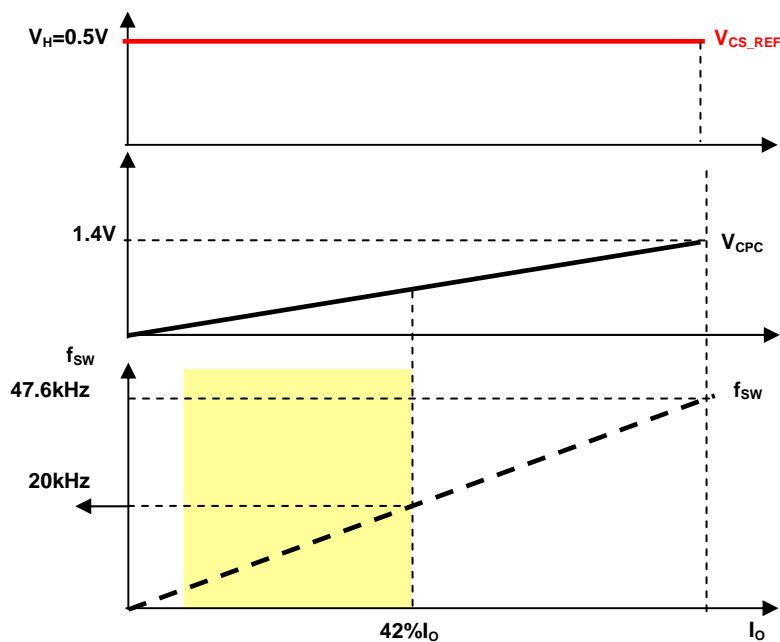
2. Five Aspects for System Design

1. Low Standby Power Design
2. Switching Frequency Design
3. Transformer and Power Devices Design
4. Feedback Resistors Design
5. Line Compensation Design

In order to achieve low standby power, AP3771 decreases the minimum operating voltage. In order to achieve the lower power loss performance, the startup resistor $R_{ST1}+R_{ST2}$ should be as high as possible on the premise of meeting turn on delay time requirement. The selection of dummy load resistor is a tradeoff between standby power and I-V Curve.

2.1 Low Standby Power Design

2.2 Switching Frequency Design


 Figure 3. Relationship Between V_{CPC} , f_{sw} and I_o at Constant Peak Current Mode

When the constant peak current is adopted, the voltage of CPC pin is increased linearly with load increasing. The maximum value of V_{CPC} is equal to

$$\frac{t_{ONS}}{t_{SW}} \cdot VDD = \frac{4}{8} \cdot 3.5V = 1.75V \quad (1)$$

The primary current $i_p(t)$, as shown in Figure 2, is sensed by a current sense resistor R_{CS} . The power transferring from input to output is given by:

$$P_O = \frac{1}{2} \cdot L_P \cdot I_{pk}^2 \cdot f_{SW} \cdot \eta \quad (2)$$

Where, the f_{SW} is the switching frequency. η is the efficiency of the system. When the peak current I_{PK} is constant, the output power depends on the switching frequency f_{SW} . f_{SW} is linearly increased with load increasing.

In AP3771, two-segmented peak current is used to realize audio noise suppression. The peak current is about 0.5V when $I_O > 42\% I_{Omax}$, and the peak current is about 0.5V/1.5 when $I_O < 42\% I_{Omax}$.

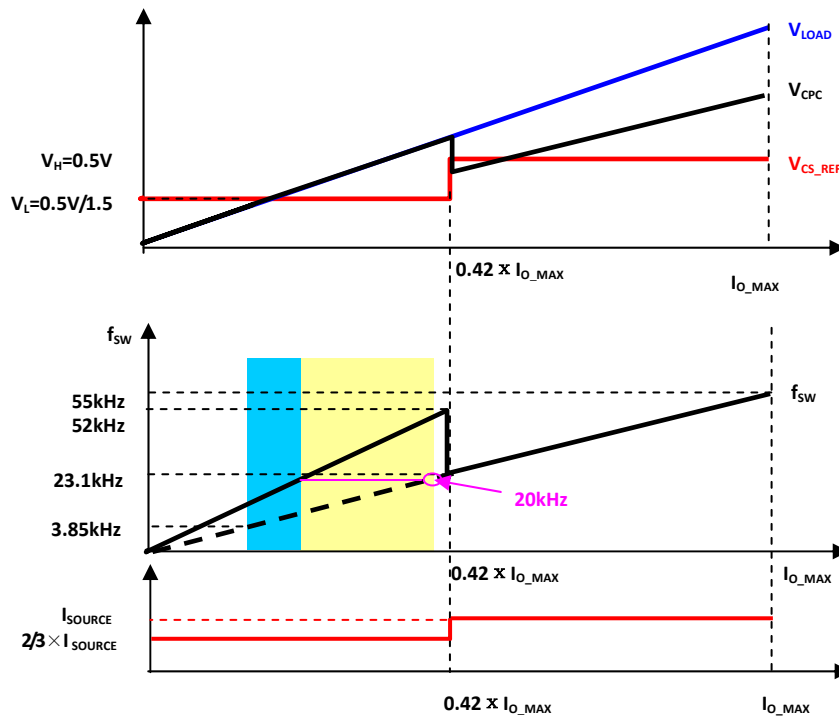


Figure 4. Relationship Between V_{CPC} , f_{SW} and I_O at Variable Peak Current Mode

So, the voltage of CPC pin (V_{CPC}) and switching frequency (f_{SW}) has a leap at about 42% of load. At the leap point, if the peak current is changed from 0.5V (high I_{PK}) to 0.33V (low I_{PK}), the voltage of CPC pin at low I_{PK} will be

increased to 1.5 times of V_{CPC} at high I_{PK} , and the switching frequency f_{SW} at low I_{PK} will be increased to 2.25 times of f_{SW} at high I_{PK} . So the range of load working in the audio frequency is suppressed.

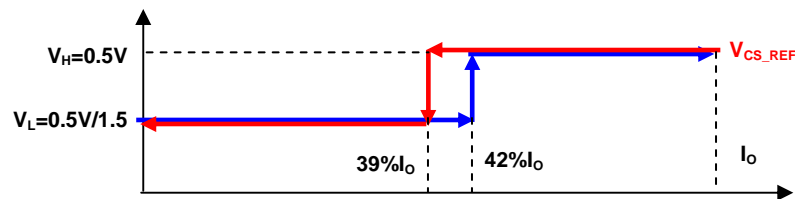


Figure 5. Hysteresis at Conversion Between Low I_{PK} and High I_{PK}

In order to avoid oscillation, a hysteresis is added at the conversion between low I_{pk} and high I_{pk} . Considering the relationship between audio noise and flux density of transformer, $\Delta B \leq 2500$ gauss is better for audio noise suppression.

The low limitation of maximum switching frequency is given by audio noise suppression. And the upper limit of the AP3771 can be up to 120kHz. But this is only the limit of the IC; the finally designed maximum switching frequency is determined by the tradeoff between the efficiency, mechanical dimensions and thermal performance.

2.3 Transformer and Power Devices Design

In Constant Current operation of AP3771, the CC loop control function of AP3771 will keep a fixed proportion between D1 (in Figure 1) on-time t_{ONS} and D1 off-time t_{OFFS} (in Figure 2) by discharging or charging a capacitor embedded in the IC. The fixed proportion is

$$\frac{t_{ONS}}{t_{OFFS}} = \frac{4}{4} \quad (3)$$

The relationship between the output constant-current and secondary peak current I_{PKS} is given by:

$$I_O = \frac{1}{2} \cdot I_{PKS} \cdot \frac{t_{ONS}}{t_{ONS} + t_{OFFS}} \quad (4)$$

At the instant of D1 turn-on, the primary current transfers to the secondary at an amplitude of:

$$I_{PKS} = \frac{N_P}{N_S} \cdot I_{PK} \quad (5)$$

Thus the output constant-current is given by:

$$I_O = \frac{1}{2} \cdot \frac{N_P}{N_S} \cdot I_{PK} \cdot \frac{t_{ONS}}{t_{ONS} + t_{OFFS}} = \frac{1}{4} \cdot \frac{N_P}{N_S} \cdot I_{PK} \quad (6)$$

2.3.1 Calculate the Max. turn ratio of XFMR (N_{MAX})

The maximum turn ratio of XFMR should be designed first, which is to ensure that the system should work in DCM in all working conditions, especially at the min. input voltage and full load.

As we know, if the system can meet equation (7) at minimum input voltage and full load, it can work in DCM under all working conditions.

$$t_{SW} \geq t_{ONP} + t_{ONS} \quad (7)$$

For the primary side current,

$$t_{ONP} = I_{PK} \cdot \frac{L_P}{V_{INDC}} \quad (8)$$

Where L_P is the inductance of primary winding.

V_{INDC} is the rectified DC voltage of input.

When V_{INDC} is the minimum value, the maximum t_{ONP} can be obtained. So,

$$t_{ONP_MAX} = I_{PK} \cdot \frac{L_P}{V_{INDC_MIN}} \quad (9)$$

For the secondary side current,

$$t_{ONS} = I_{PKS} \cdot \frac{L_S}{V_S} \quad (10)$$

In (10), L_S is the inductance of secondary winding.

$V_S = V_O + V_d$, V_d is the forward voltage of secondary diode.

For (10), in CV regulation, the V_S is a constant voltage, so t_{ONS} is a constant value with different input voltage.

In FLYBACK converter, when the primary transistor turns ON, the energy stored in the magnetizing inductance L_P . So the power transferring from the input to the output is given by,

$$P_{in}' = P_{in} \cdot \eta_{in} = V_{in} \cdot I_{in} \cdot \eta_{in} \quad (11)$$

$$P_{in}' = \frac{1}{2} \cdot L_P \cdot I_{PK}^2 \cdot f_{SW} \quad (12)$$

Here, P_{in}' is input power of transformer, not including all of the power loss at primary side (Rectifier, RCD snubber, BJT and so on).

η_{in} is definition to the input efficiency of system, which is about 0.9.

Then,

$$t_{SW} = \frac{L_P \cdot I_{PK}^2}{2 \cdot P_{in} \cdot \eta_{in}} \quad (13)$$

t_{SW} , t_{ONP} and t_{ONS} in (7) are replaced with (13), (9) and (10),

$$\frac{L_P \cdot I_{PK}^2}{2 \cdot P_{in} \cdot \eta_{in}} \geq I_{PKS} \cdot \frac{L_S}{V_S} + I_{PK} \cdot \frac{L_P}{V_{INDC_MIN}} \quad (14)$$

Because the peak current and inductance of primary side and secondary side have the following relationship,

$$I_{PKS} = N \cdot I_{PK} \cdot \eta_i \quad (15)$$

$$L_s = \frac{L_p}{N^2} \quad (16)$$

Here, N is the turn ratio of primary and secondary sides. $\eta_i = 0.95$, which is the efficiency of I_{PK} and I_{PKS} .

With (14), (15) and (16), then,

$$\frac{I_{pk}}{2 \cdot P_{in} \cdot \eta_{in}} \geq \frac{\eta_i}{V_s \cdot N} + \frac{1}{V_{in}} \quad (17)$$

Because,

$$P_{in} = \frac{V_o \cdot I_o}{\eta} \quad (18)$$

η is the system efficiency from input to output.

At full load, the system will work in the boundary of CC regulation. I_o can be given by,

$$I_o = \frac{1}{2} \cdot \frac{t_{ONS}}{t_{SW}} \cdot I_{pks} \quad (19)$$

Then, I_{PKS} can be defined,

$$I_{pks} = k \cdot I_o \quad (20)$$

In the design of AP3771,

$$k = \frac{2 \cdot t_{SW}}{t_{ONS}} = 4 \quad (21)$$

The following can be obtained,

$$N \leq N_{max} = V_{indc_min} \cdot \left(\frac{k \cdot \eta}{2 \cdot V_o \cdot \eta_{in} \cdot \eta_i} - \frac{\eta_i}{V_o + V_d} \right) \quad (22)$$

Then N is fixed as less than or equal to N_{MAX} .

2.3.2 Calculate the peak current of primary side and current sensed resistor (I_{PK} & R_{CS})

I_{PK} can be calculated by the output current.

$$I_{pk} \cdot \eta_i = \frac{I_{pks}}{N} = \frac{k \cdot I_o}{N} \quad (23)$$

Here, $k=4$, $\eta_i = 0.9$, which is the efficiency of I_{PK} and I_{PKS} .

In AP3771, 0.5V is an internal reference voltage. If the sensed voltage V_{CS} reaches 0.5V, the power MOSFET will be shut down and t_{ONP} will be ended.

$$R_{CS} = \frac{0.5V}{I_{pk}} \quad (24)$$

So R_{CS} can be obtained from (24) and selected with a real value from the standard resistor series. We recommend

using 1% tolerance resistors for R_{CS} . After R_{CS} is selected, I_{PK} should be modified based on the selected R_{CS} .

From formula (23), the turn ratio of primary and secondary side N can be re-calculated.

$$N = \frac{k \cdot I_o}{I_{pk} \cdot \eta_i} (k=4) \quad (25)$$

2.3.3 Calculate the inductance of primary side--- L_p

The primary side inductance L_p determines the stored energy. L_p should be big enough to store enough energy, so that P_{O_Max} can be obtained first, from the system version.

From formula (18), the output power can be given by,

$$P_o = \frac{1}{2} \cdot L_p \cdot I_{pk}^2 \cdot f_{SW} \cdot \frac{\eta}{\eta_{in}} \quad (26)$$

Where f_{SW} was set by the user based on definite requirement.

Then, L_p can be gotten by,

$$L_p = \frac{2 \cdot P_o}{I_{PK}^2 \cdot f_{SW}} \cdot \frac{\eta_{in}}{\eta} \quad (27)$$

2.3.4 Calculate the turns of primary, secondary and auxiliary

The turns of primary winding,

$$N_p = \frac{L_p \cdot I_{PK}}{Ae \cdot \Delta B} \geq \frac{L_p \cdot I_{PK}}{Ae \cdot B_{max}} \quad (28)$$

First, the reasonable core-type and ΔB should be selected. Ae can be gotten automatically after core-type is selected.

As we know,

$$N_s = \frac{N_p}{N} \quad (29)$$

And the turns of auxiliary winding,

$$N_A = \frac{N_s \cdot V_A}{V_S} \quad (30)$$

Where, V_S is equal to $V_o + V_d$. $V_A = V_{CC} + V_{da}$, V_{CC} is the set IC supply voltage and V_{da} is the voltage drop of the auxiliary diode.

For AP3771, the typical value of UVLO is decreased to 6.5V, so the supply voltage of IC, V_{CC} can be set to a typical value---13V.

2.3.5 Check the maximum duty cycle of primary side

After turn ratio of primary side and secondary side is

designed, the maximum duty cycle of primary side at low line voltage can be calculated again.

Considering the Volt-second balance between magnetizing and de-magnetizing, the formula of duty cycle is

$$D = \frac{(V_o + V_d) \cdot N \cdot 0.5}{V_{indc}} \quad (31)$$

2.3.6 Select diodes of secondary and auxiliary sides

Maximum reverse voltage of secondary side,

$$V_{dr} = V_s + \frac{V_{indc_max} \cdot N_s}{N_p} \quad (32)$$

Maximum reverse voltage of auxiliary side,

$$V_{dar} = V_A + \frac{V_{indc_max} \cdot N_A}{N_p} \quad (33)$$

In (32) and (33), the maximum DC input voltage should be used.

2.3.7 Select the primary side MOSFET

$$V_{dc_max} = V_{dc_spike} + V_{indc_max} + \frac{V_s \cdot N_p}{N_s} \quad (34)$$

Be careful that the value of V_{dc_spike} will be different with different snubber circuit.

Design Example 1 (for 12V/1A Adapter Application)

Specification:

Input voltage: 90V_{AC} to 264V_{AC}

Output voltage @ cable: V_{O_CABLE}=12V

Output current: I_O=1A

Output voltage @ PCB, V_O=12.3V (with 1.8m AWG24 cable)

k=2* T_{SW}/T_{ONS}=4

Efficiency: $\eta_i = 0.9$

Other setting by users:

Switching frequency: f_{SW}=60kHz

Forward voltage of secondary diode: V_d=0.4V

Forward voltage of auxiliary diode: V_{da}=1.1V

V_{CC} voltage: V_{CC}=18V

Core_type: EE19/16 (Ae=22.4mm²), Bmax<3000GS

V_{dc_SPIKE}=50V (with snubber circuit)

Design Steps:

1) Calculate the maximum turn ratio of XFMR

$$N_{MAX} = V_{indc_min} \cdot \left(\frac{k \cdot \eta}{2 \cdot V_o \cdot \eta_{in} \cdot \eta_i} - \frac{\eta_i}{V_o + V_d} \right) = 13.96 \quad (35)$$

$$V_{indc_min} = V_{mac_min} \cdot \sqrt{2} - 40,$$

We choose N=11

2) Calculate the peak current of primary side and current sense resistor (I_{PK} & R_{CS})

$$I_{pk} = \frac{I_{pks}}{N \cdot \eta_i} = \frac{k \cdot I_o}{N \cdot \eta_i} = 0.638 \quad (36)$$

$$R_{CS} = \frac{V_{CS_ref}}{I_{pk}} = 0.846 \quad (37)$$

We choose

$$R_{CS} = 0.85\Omega, \quad (38)$$

$$I_{PK} = 0.64A, \quad (39)$$

3) Calculate the inductance of primary side---L_P

$$L_p = \frac{2 \cdot P_o}{I_{PK}^2 \cdot f_{SW}} \cdot \frac{\eta_{in}}{\eta} = 1.15mH \quad (40)$$

We choose L_p=1.15mH

4) Calculate the turns of primary, secondary and auxiliary sides (N_P, N_S, N_A)

$$N_p = \frac{L_p \cdot I_{PK}}{Ae \cdot \Delta B} \geq \frac{L_p \cdot I_{PK}}{Ae \cdot B_{max}} = 109.43 \quad (41)$$

$$N_p = 110$$

$$N_s = \frac{N_p}{N} = 10 \quad (42)$$

$$N_A = \frac{N_s \cdot V_A}{V_S} = 15 \quad (43)$$

5) Check the maximum duty cycle of primary side

The maximum duty cycle of primary side is calculated as following,

$$D = \frac{(V_o + V_d) \cdot N \cdot 0.4}{V_{indc}} = 0.55 \quad (44)$$

6) Select diodes of secondary and auxiliary sides

Maximum reverse voltage of secondary and auxiliary side,

$$V_{dr} = V_S + \frac{V_{indc_max} \cdot N_S}{N_P} \quad (45)$$

$$V_{dar} = V_A + \frac{V_{indc_max} \cdot N_A}{N_P} = 70V \quad (48)$$

$$V_{indc_max} = 265V \cdot \sqrt{2} \quad (46)$$

7) Select primary side MOSFET

$$V_{dr} = V_S + \frac{V_{indc_max} \cdot N_S}{N_P} = 47V \quad (47)$$

$$V_{ds_mos} = V_{dc_spike} + V_{indc_max} + \frac{V_S \cdot N_P}{N_S} = 564V \quad (49)$$

Design Results Summary:

1. Calculate the maximum peak current of primary side and R _{CS}			
I _{PK} =	640	mA	Peak current of primary side
R _{CS} =	0.85	Ω	Current sensed resistor
2. Design transformer			
L _P =	1.15	mH	Inductance of primary side
N=	11	Turn ratio of primary and secondary	
N _P =	110	T	Turns of primary side
N _S =	10	T	Turns of secondary side
N _A =	15	T	Turns of auxiliary side
D _{MAX}	0.55		Maximum duty cycle of primary side at V _{INDC} =80V
3. Select diode and primary transistor			
V _{dr} =	47	V	Maximum reverse voltage of secondary diode
V _{dar} =	70	V	Maximum reverse voltage of auxiliary diode
V _{dcMax} =	564	V	Voltage stress of primary transistor

Design Example 2 (for 12V/1.5A Adapter Application)

Specification:

Input voltage: 90V_{AC} to 264V_{AC}

Output voltage @ cable: V_{O_CABLE}=12V

Output current: I_O=1.5A

Output voltage @ PCB, V_O=12.24V (with 1.5m AWG22 cable)

k=2*T_{SW}/T_{ONS}=4

Efficiency: η = 0.75, η_{in} = 0.9, η_i = 0.9

Other setting by users:

Switching frequency: f_{SW}=50kHz

Forward voltage of secondary diode: V_d=0.4V

Forward voltage of auxiliary diode: V_{da}=1.1V

V_{CC} voltage: V_{CC}=14V

Core_type: EE20 (Ae=31mm²), B_{max}<3000GS

V_{dc_SPIKE}=50V (with snubber circuit)

$$N_{MAX} = V_{indc_min} \cdot \left(\frac{k \cdot \eta}{2 \cdot V_O \cdot \eta_{in} \cdot \eta_i} - \frac{\eta_i}{V_O + V_d} \right) = 14.05 \quad (50)$$

$$V_{indc_min} = V_{inac_min} \cdot \sqrt{2} - 40,$$

We choose N=10

2) Calculate the peak current of primary side and current sense resistor (I_{PK} & R_{CS})

$$I_{pk} = \frac{I_{pks}}{N \cdot \eta_i} = \frac{k \cdot I_O}{N \cdot \eta_i} = 0.97 \quad (51)$$

$$R_{CS} = \frac{V_{CS_ref}}{I_{pk}} = 0.56 \quad (52)$$

We choose

$$R_{CS} = 0.56\Omega, \quad (53)$$

$$I_{PK} = 0.97A, \quad (54)$$

Design Steps:

1) Calculate the maximum turn ratio of XFMR

3) Calculate the inductance of primary side---L_P

$$L_p = \frac{2 \cdot P_o}{I_{PK}^2 \cdot f_{SW}} \cdot \frac{\eta_m}{\eta} = 0.89mH \quad (55)$$

We choose $L_p=0.9mH$.

4) Calculate the turns of primary, secondary and auxiliary sides (N_p, N_s, N_A)

$$N_p = \frac{L_p \cdot I_{PK}}{Ae \cdot \Delta B} \geq \frac{L_p \cdot I_{PK}}{Ae \cdot B_{max}} = 92.9 \quad (56)$$

$$N_p = 100$$

$$N_s = \frac{N_p}{N} = 10 \quad (57)$$

$$N_A = \frac{N_s \cdot V_A}{V_S} = 12 \quad (58)$$

5) Check the maximum duty cycle of primary side

The maximum duty cycle of primary side is calculated as following,

$$D = \frac{(V_o + V_d) \cdot N \cdot 0.4}{V_{indc}} = 0.48 \quad (59)$$

6) Select diodes of secondary and auxiliary sides

$$V_{dr} = V_s + \frac{V_{indc_max} \cdot N_s}{N_p} \quad (60)$$

$$V_{indc_max} = 265V \cdot \sqrt{2} \quad (61)$$

$$V_{dr} = V_s + \frac{V_{indc_max} \cdot N_s}{N_p} = 50V \quad (62)$$

$$V_{dar} = V_A + \frac{V_{indc_max} \cdot N_A}{N_p} = 60V \quad (63)$$

7) Select primary side MOSFET

$$V_{ds_mos} = V_{dc_spike} + V_{indc_max} + \frac{V_s \cdot N_p}{N_s} = 550V \quad (64)$$

Design Results Summary:

1. Calculate the maximum peak current of primary side and R_{CS}			
$I_{PK} =$	970	mA	Peak current of primary side
$R_{CS} =$	0.56	Ω	Current sensed resistor
2. Design transformer			
$L_p =$	0.9	mH	Inductance of primary side
$N =$	10		Turn ratio of primary and secondary
$N_p =$	100	T	Turns of primary side
$N_s =$	10	T	Turns of secondary side
$N_A =$	12	T	Turns of auxiliary side
$D_{MAX} =$	0.48		Maximum duty cycle of primary side at $V_{INDC}=80V$
3. Select diode and primary transistor			
$V_{dr} =$	50	V	Maximum reverse voltage of secondary diode
$V_{dar} =$	60	V	Maximum reverse voltage of auxiliary diode
$V_{dcMax} =$	550	V	Voltage stress of primary transistor

2.4 Feedback Resistors Design

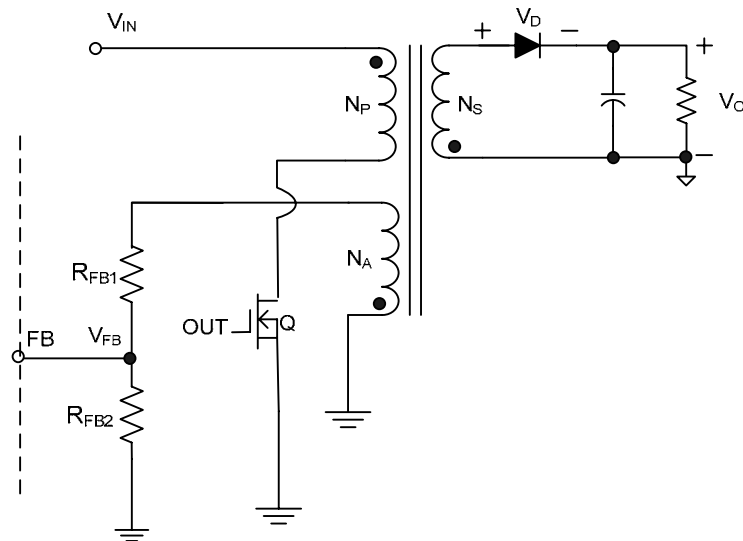


Figure 6. Feedback Resistors Circuit

From above Figure 6,

$$V_o = V_{FB} \cdot \frac{(R_{FB1} + R_{FB2})}{R_{FB2}} \cdot \frac{N_S}{N_A} - V_D \quad (65)$$

Through adjusting R_{FB1} and R_{FB2} , a suitable output voltage can be achieved. The recommended values of R_{FB1} and R_{FB2} are within $5k\Omega$ to $50k\Omega$.

2.5 Line Compensation Design

The internal line compensation function in AP3771 is shown in Figure 7. S1 is closed when the primary switch is “ON”. The line voltage can be detected from the FB pin. The detected voltage internally compensates the peak current. So the line compensation is determined by R_{LINE} . In different application, the value of R_{LINE} is different.

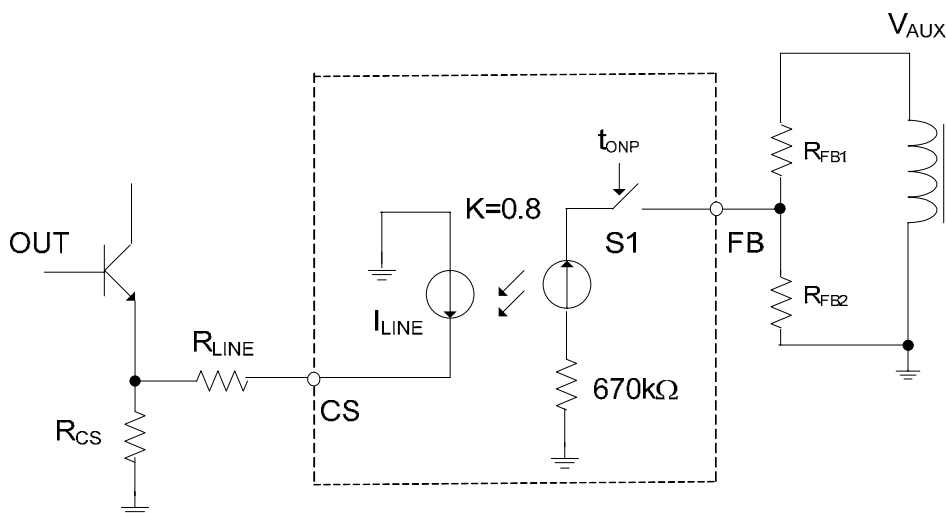


Figure 7. Line Compensation Circuit

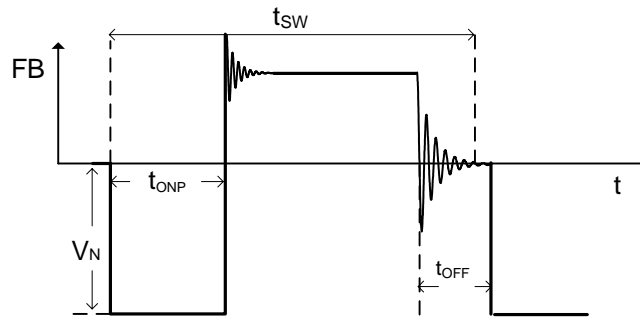


Figure 8. Waveform of FB Pin

The negative voltage V_N of FB pin (in Figure 8) is linear to line voltage. The AP3771 samples V_N to realize the line compensation.

$$V_N = \frac{R_{FB2}}{R_{FB1} + R_{FB2}} \cdot \frac{N_a}{N_p} \cdot V_{indc} \quad (66)$$

The compensated voltage of line compensation (V_{CS_LINE}) can be calculated by the following formula,

$$\begin{aligned} V_{cs_line} &= R_{line} \cdot K \cdot \frac{1}{670k} \cdot V_N \\ &= R_{line} \cdot 0.8 \cdot \frac{1}{670k} \cdot \frac{R_{FB2}}{R_{FB1} + R_{FB2}} \cdot \frac{N_a}{N_p} \cdot V_{indc} \end{aligned} \quad (67)$$

So, R_{LINE} can be adjusted to achieve excellent line regulation of output current.

3. Summary

In order to get good performance of AP3771, it's important to design transformer, line compensation and feedback resistance correctly. This application only gives a preliminary design guideline about these aspects and considers ideal conditions, so some parameters need to be adjusted slightly on the basis of the calculated results.